SCLS424D - JUNE 1998 - REVISED JANUARY 2000

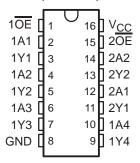
- EPIC™ (Enhanced-Performance Implanted CMOS) Process
- Operating Range 2-V to 5.5-V V_{CC}
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)
- Package Options Include Plastic Small-Outline (D), Shrink Small-Outline (DB), Thin Very Small-Outline (DGV), and Thin Shrink Small-Outline (PW) Packages, Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) DIPs

description

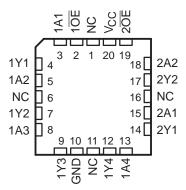
The 'AHC367 devices are hex buffers and line drivers designed for 2-V to 5.5-V V_{CC} operation.

These devices are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. The 'AHC367 devices are organized as dual 4-line and 2-line buffers/drivers with active-low output-enable ($1\overline{OE}$ and $2\overline{OE}$) inputs. When \overline{OE} is low, the device passes noninverted data from the A inputs to the Y outputs. When \overline{OE} is high, the outputs are in the high-impedance state.

SN54AHC367 ... J OR W PACKAGE SN74AHC367 ... D, DB, DGV, N, OR PW PACKAGE (TOP VIEW)



SN54AHC367 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54AHC367 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74AHC367 is characterized for operation from –40°C to 85°C.

FUNCTION TABLE (each buffer/driver)

INP	JTS	OUTPUT
OE	Α	Υ
L	Н	Н
L	L	L
Н	Х	Z

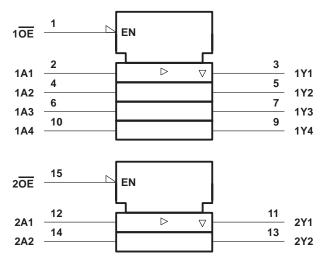


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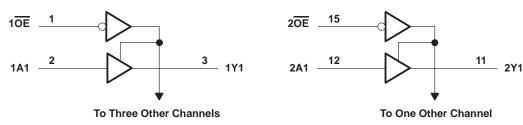


logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, DB, DGV, J, N, PW, and W packages.

logic diagram (positive logic)



Pin numbers shown are for the D, DB, DGV, J, N, PW, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V _{CC}		–0.5 V to 7 V
Input voltage range, V _I (see Note 1)		–0.5 V to 7 V
Output voltage range, VO (see Note 1)		$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, $I_{IK}(V_I < 0)$		–20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CO}	c)	±20 mA
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	- 	±25 mA
Continuous current through V _{CC} or GND		±75 mA
Package thermal impedance, θ _{JA} (see Note 2):	: D package	73°C/W
•	DB package	82°C/W
	DGV package	120°C/W
	N package	67°C/W
	PW package	108°C/W
Storage temperature range, T _{stg}		–65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.



recommended operating conditions (see Note 3)

			SN54A	SN54AHC367		SN74AHC367		
			MIN	MAX	MIN	MAX	UNIT	
Vcc	Supply voltage		2	5.5	2	5.5	V	
		V _{CC} = 2 V	1.5		1.5			
VIН	High-level input voltage	V _{CC} = 3 V	2.1		2.1		V	
		V _{CC} = 5.5 V	3.85		3.85			
		V _{CC} = 2 V	T	0.5		0.5		
VIL	Low-level input voltage	V _{CC} = 3 V		0.9		0.9	V	
		V _{CC} = 5.5 V		1.65		1.65		
٧ı	Input voltage		0,	5.5	0	5.5	V	
Vo	Output voltage		9	Vcc	0	VCC	V	
		V _{CC} = 2 V	20	-50		-50	μΑ	
IOH	High-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$	0	-4		-4	mA	
		$V_{CC} = 5 V \pm 0.5 V$		-8		-8		
		V _{CC} = 2 V		50		50	μΑ	
lOL	Low-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		4		4	mA	
		$V_{CC} = 5 V \pm 0.5 V$		8		8	IIIA	
Δt/Δν	Input transition rice or fall rate	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		100		100	ns/V	
ΔΨΔΨ	Input transition rise or fall rate $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$			20		20	115/ V	
TA	Operating free-air temperature		-55	125	-40	85	°C	

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETER	TEST CONDITIONS	Vaa	T _A = 25°C			SN54A	HC367	SN74AI	UNIT	
PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	0.1 0.1 0.44 0.44 ±1 ±2.5 40	UNIT
		2 V	1.9	2		1.9		1.9		
	I _{OH} = -50 μA	3 V	2.9	3		2.9		2.9		
VOH		4.5 V	4.4	4.5		4.4		4.4		V
	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		2.48		
	$I_{OH} = -8 \text{ mA}$	4.5 V	3.94			3.8		3.8		
		2 V			0.1		0.1		0.1	
	I _{OL} = 50 μA	3 V			0.1		0.1		0.1	
V _{OL}		4.5 V			0.1	. 4	0.1		0.1	V
	I _{OL} = 4 mA	3 V			0.36	(0)	0.5		0.44	
	I _{OL} = 8 mA	4.5 V			0.36	90	0.5		0.44	
lj	V _I = V _{CC} or GND	0 V to 5.5 V			±0.1	d'a	±1*		±1	μΑ
loz	$\frac{V_L}{OE} = V_{CC}$ or GND, $V_O = V_{CC}$ or GND,	5.5 V			±0.25		±2.5		±2.5	μΑ
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			4		40		40	μΑ
Ci	$V_I = V_{CC}$ or GND	5 V		3	10				10	pF
Co	$V_O = V_{CC}$ or GND	5 V		5.1						pF

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested at $V_{CC} = 0 \text{ V}$.



SN54AHC367, SN74AHC367 HEX BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

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switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T,	Վ = 25 °C	;	SN54Al	HC367	SN74AI	HC367	UNIT	
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
^t PLH	А	Y	C _I = 15 pF		4.7*	8.3*	1*	10*	1	10	ns	
t _{PHL}	A	'	CL = 13 pr		4.7*	83*	1*	10*	1	10	115	
^t PZH	ŌĒ	Y	C _L = 15 pF		5.1*	10.5*	1*	12.5*	1	12.5	ns	
t _{PZL}	OE .	'	GE = 13 bis		5.1*	10.5*	1*	12.5*	1	12.5	115	
^t PHZ	ŌĒ	ŌĒ	Y	C _L = 15 pF		4*	10.5*	1*	12.5*	1	12.5	ns
t _{PLZ}			'	OL = 13 pi		4.9*	10.5*	1* <	12.5*	1	12.5	113
^t PLH	А	Y	C _I = 50 pF		6.1	11.8	15	13.5	1	13.5	20	
^t PHL	A	1	CL = 50 pr		6.2	11.8	70	13.5	1	13.5	ns	
^t PZH	ŌĒ	Y	C ₁ = 50 pF		6.4	14	0 1	16	1	16	ns	
t _{PZL}	OE	'	CL = 30 pr		6.8	14	1	16	1	16	115	
^t PHZ	ŌĒ	Y	C _L = 50 pF		6.2	13.6	1	15.5	1	15.5	ns	
t _{PLZ}	OL .	'	OL = 00 pi		7.3	13.6	1	15.5	1	15.5	113	

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

	-			_	_						
DADAMETED	FROM	то	LOAD	T	λ = 25°C	;	SN54AI	HC367	SN74AI	HC367	UNIT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
^t PLH	_	Y	C 15 pE		3.4*	5.9*	1*	7*	1	7	20
^t PHL	Α	ī	C _L = 15 pF		3.6*	5.9*	1*	7*	1	7	ns
^t PZH	ŌĒ	Y	C _L = 15 pF		3.6*	7.2*	1*	8.5*	1	8.5	ns
t _{PZL}	OE OE	'			3.8*	7.2*	1*	8.5*	1	8.5	115
^t PHZ	OE	Υ	C ₁ = 15 pF		2.6*	7.2*	0*	8.5*	0	8.5	ns
t _{PLZ}		OE	'	O[= 15 pr		2.6*	7.2*	0* <	8.5*	0	8.5
^t PLH	А	Y	C: - 50 pF		4.3	7.9	2	9	1	9	ns
^t PHL	A	ī	C _L = 50 pF		4.5	7.9	70	9	1	9	115
^t PZH	ŌĒ	Y	C 50 pF		4.6	9.2	& 1	10.5	1	10.5	20
tPZL	OE .	ſ	C _L = 50 pF		4.9	9.2	1	10.5	1	10.5	ns
^t PHZ	ŌĒ	Y	C _I = 50 pF		3.4	9.2	0	10.5	0	10.5	ns
^t PLZ]	'	OL = 30 pr		4.5	9.2	0	10.5	0	10.5	113

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.

noise characteristics, V_{CC} = 5 V, C_L = 50 pF, T_A = 25°C (see Note 4)

	PARAMETER	SN7	UNIT		
	PARAMIETER	MIN	TYP	MAX	UNIT
V _{OL(P)}	Quiet output, maximum dynamic V _{OL}		0.9		V
V _{OL(V)}	Quiet output, minimum dynamic V _{OL}		-0.8		V
VOH(V)	Quiet output, minimum dynamic VOH		4.2		V
VIH(D)	High-level dynamic input voltage	3.5			V
V _{IL(D)}	Low-level dynamic input voltage			1.5	V

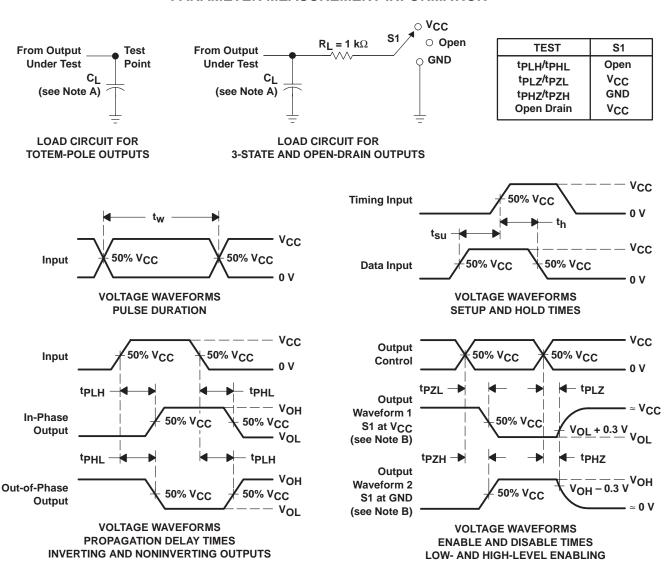
NOTE 4: Characteristics are for surface-mount packages only.



operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER			TEST CO	ONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	Outputs enabled	No load,	f = 1 MHz	22.4	pF

PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_{O} = 50 \Omega$, $t_{f} \leq$ 3 ns. $t_{f} \leq$ 3 ns.
 - D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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